

METHODS FOR A MULTILAYER RETAINING RING

Abstract

5 A substrate is maintained beneath a substrate mounting surface with a retaining
ring that includes a generally annular lower portion having a bottom surface for
contacting the polishing surface during polishing, and a generally annular upper portion
having a bottom surface joined to the lower portion and a top surface fixed to and
abutting the base. The lower portion is made of a plastic and the upper lower portion is
10 made of a metal which is more rigid than the plastic.

50209566.doc